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December 2013

#### FPAB30BH60

## PFC SPM® 3 Series for Single-Phase Boost PFC

#### **Features**

- UL Certified No. E209204 (UL1557)
- 600 V 30 A Single-Phase Boost PFC with Integral Gate Driver and Protection
- Very Low Thermal Resistance Using Al<sub>2</sub>O<sub>3</sub> DBC Substrate
- Full-Wave Bridge Rectifier and High-Performance Output Diode
- · Built-in NTC Thermistor for Temperature Monitoring
- · Optimized for 20kHz Switching Frequency
- Isolation Rating: 2500 Vrms/min.

#### **Applications**

· Single-Phase Boost PFC Converter

#### **Related Source**

- AN-9090 PFC SPM 3 Series User's Guide
- AN-9091 Boost PFC Inductor Design Guide

#### **General Description**

The FPAB30BH60 is a PFC SPM® 3 module providing a fully-featured, high-performance Boost PFC (Power Factor Correction) input power stage for consumer, medical, and industrial applications. These modules integrate optimized gate drive of the built-in IGBT to minimize EMI and losses, providing multiple on-module protection features including under-voltage lockout, over-current shutdown, thermal monitoring, and fault reporting. These modules also feature a full-wave rectifier, and high-performance output diode for additional space savings and mounting convenience

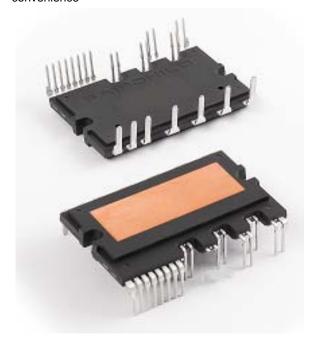


Figure 1. Package Overview

#### **Package Marking & Ordering Information**

Device	Device Marking	Package	Packing Type	Quantity
FPAB30BH60	FPAB30BH60	SPMIA-027	Rail	10

#### **Integrated Power Functions**

• PFC converter for single-phase AC / DC power conversion (please refer to Figure 3)

#### Integrated Drive, Protection, and System Control Functions

- For IGBTs: gate drive circuit, Over-Current Protection (OCP), control supply circuit Under-Voltage Lock-Out (UVLO) Protection
- · Fault signal: corresponding to OC and UV fault
- · Built-in thermistor: temperature monitoring
- Input interface: active-HIGH interface, works with 3.3 / 5 V logic, Schmitt-trigger input

#### **Pin Configuration**

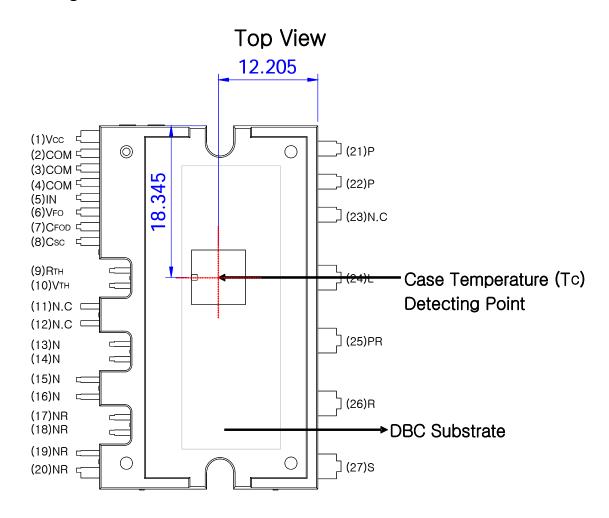


Figure 2. Top View

#### Notes :

1. For the measurement point of case temperature( $T_{\mbox{\scriptsize C}}$ ), please refer to Figure 2.

#### **Pin Descriptions**

Pin Number	Pin Name	Pin Description
1	V <sub>CC</sub>	Common Bias Voltage for IC and IGBT Driving
2,3,4	COM	Common Supply Ground
5	IN	Signal Input for IGBT
6	V <sub>FO</sub>	Fault Output
7	C <sub>FOD</sub>	Capacitor for Fault Output Duration Selection
8	C <sub>SC</sub>	Capacitor (Low-Pass Filter) for Over-Current Detection
9	R <sub>(TH)</sub>	Series Resistor for The Use of Thermistor
10	V <sub>(TH)</sub>	Thermistor Bias Voltage
11,12	N.C	No Connection*
13~16	N	IGBT Emitter
17~20	N <sub>R</sub>	Negative DC-Link of Rectifier
21,22	Р	Positive Rail of DC-Link
23	N.C	No Connection
24	L	Reactor Connection Pin
25	$P_{R}$	Positive DC-Link of Rectifier
26	R	AC Input for R-Phase
27	S	AC Input for S-Phase

<sup>\* 11</sup>th and 12th pins are cut. Please refer to package outline drawings for more detail.

### **Internal Equivalent Circuit and Input/Output Pins**

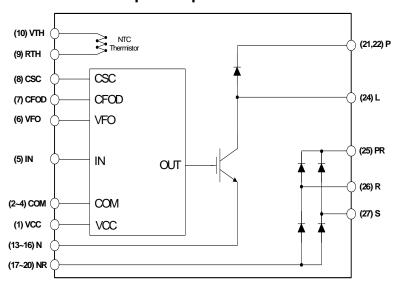


Figure 3. Internal Block Diagram

### **Absolute Maximum Ratings** ( $T_J = 25$ °C, unless otherwise specified.)

#### **Converter Part**

Symbol	Item	Condition	Rating	Unit
V <sub>i</sub>	Supply Voltage	Applied between R - S	264	$V_{rms}$
V <sub>i(Surge)</sub>	Supply Voltage (Surge)	Applied between R - S	500	V
V <sub>PN</sub>	Output Voltage	Applied between P - N	450	V
V <sub>PN(Surge)</sub>	Output Voltage (Surge)	Applied between P - N	500	V
V <sub>CES</sub>	Collector - Emitter Voltage		600	V
I <sub>FSM</sub>	Peak Forward Surge Current	Single Half Sine-Wave	250	Α
l <sub>i</sub>	Input Current (100% Load)	$T_C < 95^{\circ}C$ , $V_i = 220 \text{ V}$ , $V_{PN} = 390 \text{ V}$ , $V_{PWM} = 20 \text{ kHz}$	25	Α
I <sub>i(125%)</sub>	Input Current (125% Load)	$T_C$ < 95°C, $V_i$ = 220 V, $V_{PN}$ = 390 V, $V_{PWM}$ = 20 kHz, 1 Minite Non-Repetitive	30	А
P <sub>C</sub>	Collector Dissipation	T <sub>C</sub> = 25°C	169	W
T <sub>J</sub>	Operating Junction Temperature		-20 ~ 150	°C

#### Notes

#### **Control Part**

Symbol	Item	Condition	Rating	Unit
V <sub>CC</sub>	Control Supply Voltage	Applied between V <sub>CC</sub> - COM	20	V
V <sub>IN</sub>	Input Signal Voltage	Applied between IN - COM	-0.3 ~ V <sub>CC</sub> +0.3	V
V <sub>FO</sub>	Fault Output Supply Voltage	Applied between V <sub>FO</sub> - COM	-0.3 ~ V <sub>CC</sub> +0.3	V
I <sub>FO</sub>	Fault Output Current	Sink Current at V <sub>FO</sub> Pin	5	mA
V <sub>SC</sub>	Current Sensing Input Voltage	Applied between C <sub>SC</sub> - COM	-0.3 ~ V <sub>CC</sub> +0.3	V

#### **Total System**

Symbol	Item	Condition	Rating	Unit
T <sub>C</sub>	Module Case Operating Temperature		-20 ~ 100	°C
T <sub>STG</sub>	Storage Temperature		-40 ~ 125	°C
V <sub>ISO</sub>	Isolation Voltage	60 Hz, Sinusoidal, AC 1 Minute, Connect Pins to Heat Sink Plate	2500	V <sub>rms</sub>

#### **Thermal Resistance**

Symbol	Item	Condition	Min.	Тур.	Max.	Unit
$R_{\theta(j-c)Q}$	Junction to Case Thermal Resistance	IGBT	-	-	0.74	°C/W
$R_{\theta(j-c)F}$		FRD	-	-	1.44	°C/W
$R_{\theta(j-c)R}$		Rectifier (per 1 / 4 module)	-	-	2.07	°C/W

#### Notes:

2. For the measurement point of case temperature( $T_{\rm C}$ ), please refer to Figure 2.

<sup>1.</sup> The maximum junction temperature rating of the power chips integrated within the PFC SPM® product is 150 °C(@ $T_C \le 100$ °C). However, to insure safe operation of the PFC SPM product, the average junction temperature should be limited to  $T_{J(ave)} \le 125$ °C (@ $T_C \le 100$ °C)

#### **Electrical Characteristics** (T<sub>J</sub> = 25°C, Unless Otherwise Specified.)

#### **Converter Part**

Symbol	Item	Condition	Min.	Тур.	Max.	Unit
V <sub>CE(SAT)</sub>	IGBT Saturation Voltage	V <sub>CC</sub> = 15 V, V <sub>IN</sub> = 5 V, I <sub>C</sub> = 30 A	-	2.0	2.8	V
V <sub>FF</sub>	FRD Forward Voltage	I <sub>F</sub> = 30 A	-	1.8	2.5	V
V <sub>FR</sub>	Rectifier Forward Voltage	I <sub>F</sub> = 30 A	-	1.2	1.5	V
t <sub>ON</sub>	Switching Times	$V_{PN} = 400 \text{ V}, V_{CC} = 15 \text{ V}, I_{C} = 30 \text{ A}$	-	650	-	ns
t <sub>C(ON)</sub>		$V_{IN} = 0 \text{ V} \leftrightarrow 5 \text{ V}$ , Inductive Load	-	400	-	ns
t <sub>OFF</sub>		(Note 3)	-	620	-	ns
t <sub>C(OFF)</sub>			-	200	-	ns
t <sub>rr</sub>			-	60	-	ns
I <sub>rr</sub>			-	3.5	-	Α
I <sub>CES</sub>	Collector - Emitter Leakage Current	V <sub>CE</sub> = V <sub>CES</sub>	-	-	250	μА

#### Notes:

<sup>3.</sup>  $t_{\text{ON}}$  and  $t_{\text{OFF}}$  include the propagation delay time of the internal drive IC.  $t_{\text{C(ON)}}$  and  $t_{\text{C(OFF)}}$  are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Figure 4.

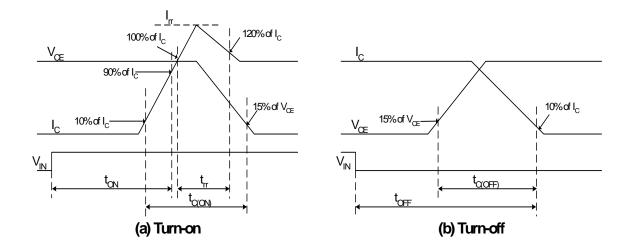


Figure 4. Switching Time Definition

#### **Control Part**

Symbol	Item	Condition	Min.	Тур.	Max.	Unit
I <sub>QCCL</sub>	Quiescent V <sub>CC</sub> Supply Current	V <sub>CC</sub> = 15 V, IN = 0 V V <sub>CC</sub> - COM	-	-	26	mA
V <sub>FOH</sub>	Fault Output Voltage	$V_{SC} = 0 \text{ V}, V_{FO} \text{ Circuit: } 4.7 \text{ k}\Omega \text{ to 5 V Pull-up}$	4.5	-	-	٧
V <sub>FOL</sub>		$V_{SC}$ = 1 V, $V_{FO}$ Circuit: 4.7 k $\Omega$ to 5 V Pull-up	-	-	0.8	٧
V <sub>SC(ref)</sub>	Over-Current Trip Level	V <sub>CC</sub> = 15 V	0.45	0.5	0.55	٧
UV <sub>CCD</sub>	Supply Circuit Under-Voltage	Detection Level	10.7	11.9	13.0	٧
UV <sub>CCR</sub>	Protection	Reset Level	11.2	12.4	13.2	٧
t <sub>FOD</sub>	Fault-Out Pulse Width	C <sub>FOD</sub> = 33 nF (Note 3)	1.4	1.8	2.0	ms
V <sub>IN(ON)</sub>	ON Threshold Voltage	Applied between IN - COM	2.8	-	-	V
V <sub>IN(OFF)</sub>	OFF Threshold Voltage		-	-	0.8	V
R <sub>TH</sub>	Resistance of Thermistor	at T <sub>TH</sub> = 25°C (Note 4, Figure 5)	-	50	-	kΩ
		at T <sub>TH</sub> = 100°C (Note 4, Figure 5)	-	2.99	-	kΩ



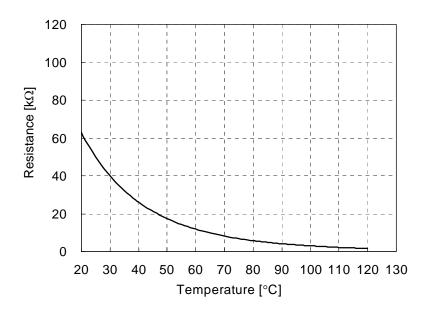


Figure 5. R-T Curve of the Built-In Thermistor

Notes:

3. The fault-out pulse width t<sub>FOD</sub> depends on the capacitance value of C<sub>FOD</sub> according to the following approximate equation: C<sub>FOD</sub> = 18.3 x 10<sup>-6</sup> x t<sub>FOD</sub>[F]

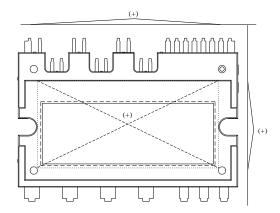
4. T<sub>TH</sub> is the temperature of know case temperature(T<sub>C</sub>), please make the experiment considering your application.

### **Recommended Operating Condition**

Symbol	Item	Condition	Min.	Тур.	Max.	Unit
V <sub>i</sub>	Input Supply Voltage	Applied between R - S	187	220	253	V <sub>rms</sub>
V <sub>PN</sub>	Output Voltage	Applied between P - N	-	380	400	V
V <sub>CC</sub>	Control Supply Voltage	Applied between V <sub>CC(L)</sub> - COM	13.5	15.0	16.5	V
dV <sub>CC</sub> /dt	Control Supply Variation		-1	-	1	V/μs
f <sub>PWM</sub>	PWM Input Frequency	T <sub>J</sub> ≤ 150°C	-	20	-	kHz
l <sub>i</sub>	Allowable Input Current	$T_C$ < 90°C, $V_i$ = 220 V, $V_{PN}$ = 380 V $V_{PWM}$ = 20 kHz	-	-	30	A <sub>peak</sub>

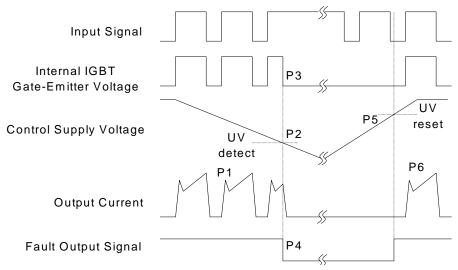
### **Mechanical Characteristics and Ratings**

Item	Co	Condition			Max.	Unit
Mounting Torque	Mounting Screw: M3	Recommended 0.62 N•m	0.51	0.62	0.72	N•m
Device Flatness	See Figure 6		0	-	+120	μm
Weight			-	15.00	-	g



**Figure 6. Flatness Measurement Position** 

#### **Time Charts of Protective Function**

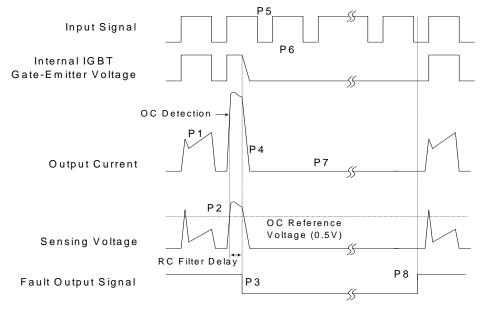


P1: Normal operation: IGBT ON and conducting current

P2 : Under-voltage detection P3 : IGBT gate interrupt P4 : Fault signal generation P5 : Under-voltage reset

P6: Normal operation: IGBT ON and conducting current

Figure 7. Under-Voltage Protection



P1: Normal operation: IGBT ON and conducting current

P2: Over current detection

P3: IGBT gate interrupt / fault signal generation

P4: IGBT is slowly turned off P5: IGBT OFF signal

P6: IGBT ON signa: but IGBT cannot be turned on during the fault output activation

P7: IGBT OFF state

P8: Fault output reset and normal operation start

**Figure 8. Over-Current Protection** 

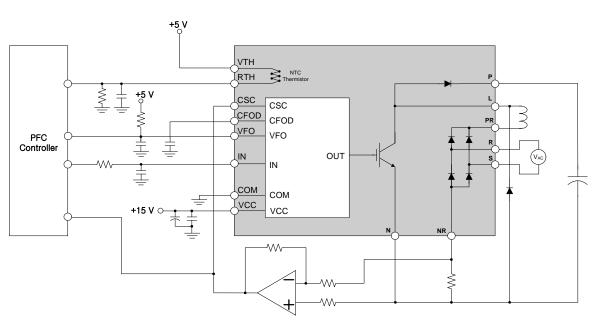
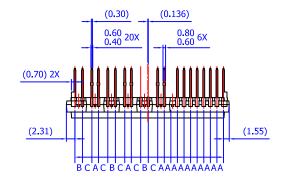


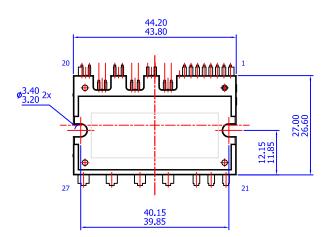
Figure 9. Application Example

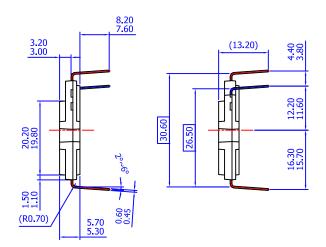
- 5. Each capacitors should be located as close to PFC SPM® product pins as possible. 6. It's recommended that anti-parallel diode should be connected with IGBT.

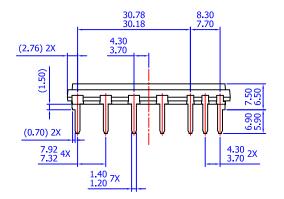


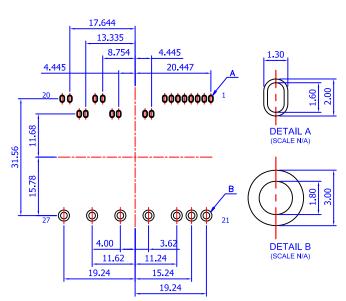
LEAD PITCH (TOLERANCE: ±0.30)

A: 1.778 B: 2.050 C: 2.531









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